

## 5 é / Descriptions

9 5 : .> // x 4 6 4 ! - } â 'ož Silicon NPN transistor in a SOT-23 Plastic Package.

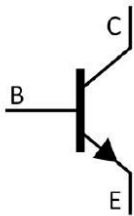
## □<sup>a</sup> / Features

2 3 ; mož  
Complementary pair with L8550M.

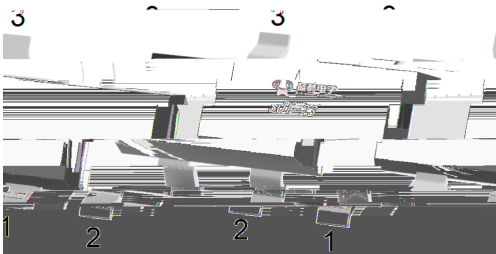
## Đ ÷ / Applications

9 ä y Ý èož  
Power amplifier applications.

## Ã W] Ô · / Equivalent Circuit



## • Ů - æ

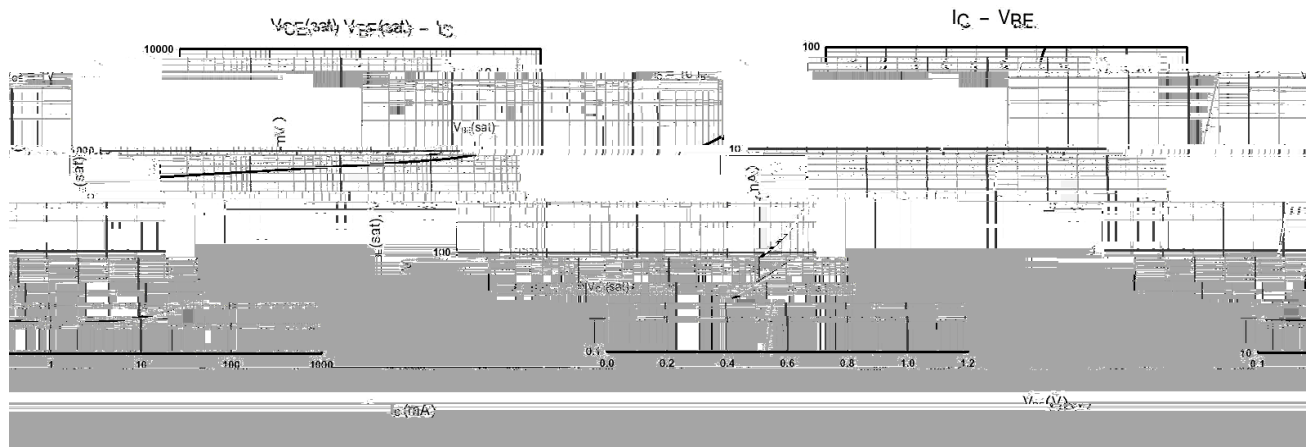
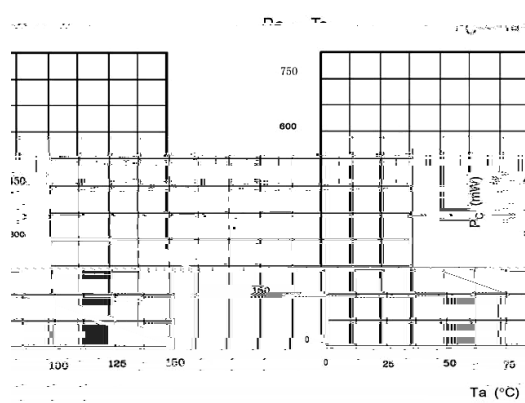
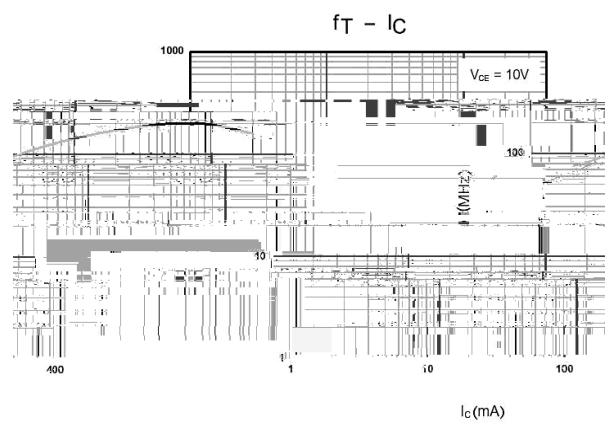


PIN1 y Base      PIN 2 y Emitter      PIN 3 y Collector

## Z Ü B , M V / h<sub>FE</sub> Classifications & Marking

| <div>@ f</div> <div>Parameter</div> | <div>... Z</div> <div>Symbol</div> | <div>f &gt;</div> <div>Rating</div> | <div>% y</div> <div>Unit</div> |
|-------------------------------------|------------------------------------|-------------------------------------|--------------------------------|
| Collector to Base Voltage           | V                                  |                                     |                                |

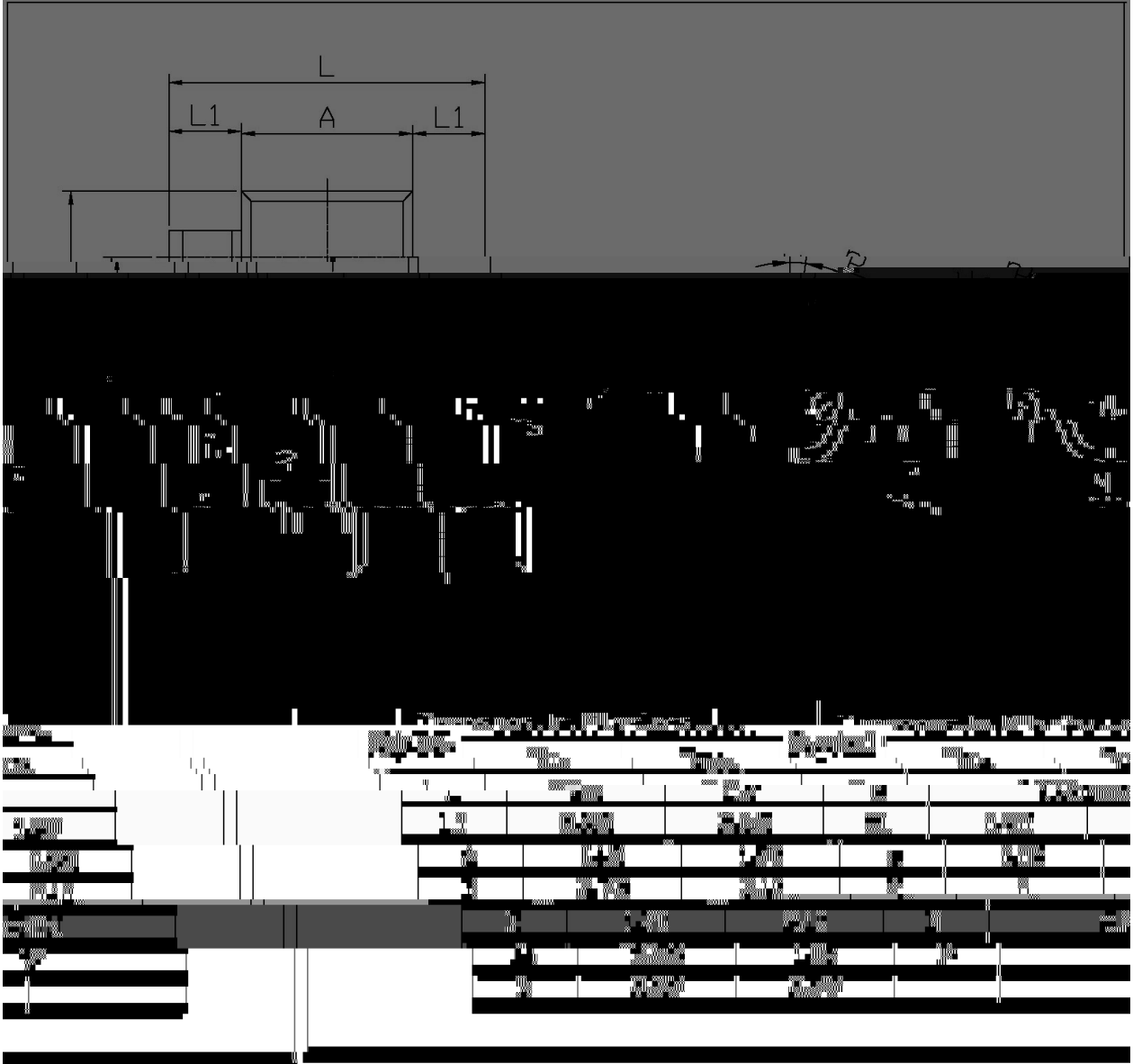
Electrical Characteristic Curve



Ø □ = ) ♂ / Package Dimensions

SOT-23

单位: mm





šWD t... • Žč (x/ ) / :KSVKXGZ[XK 6XULORK LUX /8 8KLRU] 9URJKXOTM 6

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ª ¢ y

1o• Ä ½ “† 150 ½180 - k ž • 60 ½90sec;  
2o• Q › “† 245 r5 - k ž • 4 Ò 5 r0.5sec;  
3o•D N ò i Ò 0 ,† 2 ½10 - /sec.

Note:

1.Preheating:150~180 - , Time:60~90sec.  
2.Peak Temp.:245 r5 - , Duration:5 r0.5sec.  
3. Cooling Speed: 2~10 - /sec.

ÂD /Cã p<sup>10</sup>»] / Resistance to Soldering Heat Test Conditions

“†y 260 r5 - ž • y 10 r1 sec. Temp.:260 r5 - Time:10 r1 sec

G P á / Packaging SPEC.

2 & x / REEL